

SURFACE MOUNT SUPER FAST RECOVERY RECTIFIER

Features

- ◆ Easy to pick and place
- ◆ For surface mounted applications
- ◆ Low profile package
- ◆ Built-in strain relief
- ◆ Superfast recovery times for high efficiency

Mechanical Data

Case : SOD-323

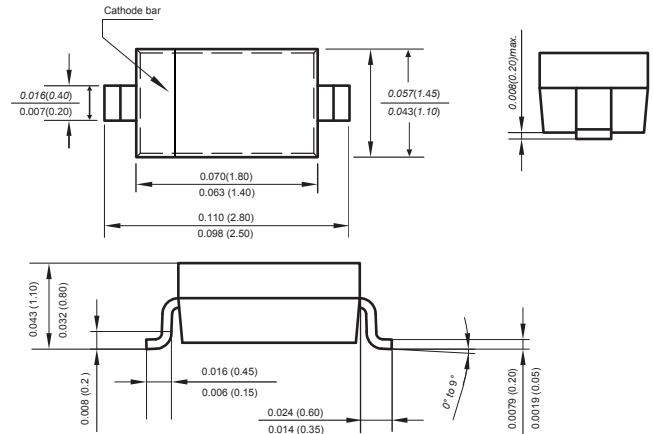
Terminals : Solderable per MIL-STD-750,Method 2026

Polarity : Polarity symbol marking on body

Mounting Position : Any

Appro .Weight : 0.00019 ounce, 0.0548 grams

SOD-323



Dimensions in inches and (millimeters)

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

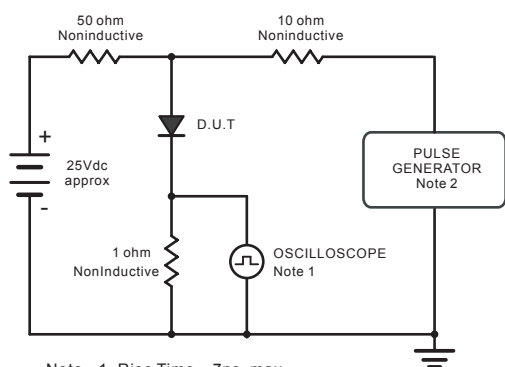
Single phase half-wave 60Hz,resistive or inductive load,for capacitive load current derate by 20%.

Parameter	SYMBOLS	SF11WS	SF12WS	SF13WS	SF14WS	SF15WS	SF16WS	SF18WS	UNITS
Marking Code		F11	F12	F13	F14	F15	F16	F18	
Maximum repetitive peak reverse voltage	V _{RMM}	50	100	150	200	300	400	600	V
Maximum RMS voltage	V _{RMS}	35	70	105	140	210	280	420	V
Maximum DC blocking voltage	V _{DC}	50	100	150	200	300	400	600	V
Maximum average forward rectified current at T _c = 125 °C	I _{F(AV)}	0.5							A
Peak forward surge current 8.3ms single half sine-wave superimposed onrated load (JEDEC Method)	I _{FSM}	15							A
Maximum instantaneous forward voltage at 0.5A	V _F	1.0				1.25		1.68	V
Maximum DC reverse current T _A =25°C at rated DCblocking voltage T _A =125°C	I _R	5 100							uA
Typical junction capacitance (NOTE 3)	C _J	15							pF
Typical reverse recovery time (NOTE 2)	T _{rr}	35							ns
Operating junction temperature range	T _J	-55 to +150							°C
Storage temperature range	T _{STG}	-55 to +150							°C

- Note:**
- 1.P.C.B. mounted with 0.2" X 0.2" (5 X 5 mm) copper pad areas.
 - 2.Measured with $I_F=0.5A, I_R=1A, I_{rr}=0.25A$
 - 3.Measured at 1.0MHz and applied reverse voltage of 4.0V D.C.
 - 4.The typical data above is for reference only.

Typical Characterisitics

Fig.1 Reverse Recovery Time Characteristic And Test Circuit Diagram



Note: 1. Rise Time = 7ns, max.
Input Impedance = 1megohm, 22pF.
2. Rises Time = 10ns, max.
Source Impedance = 50 ohms.

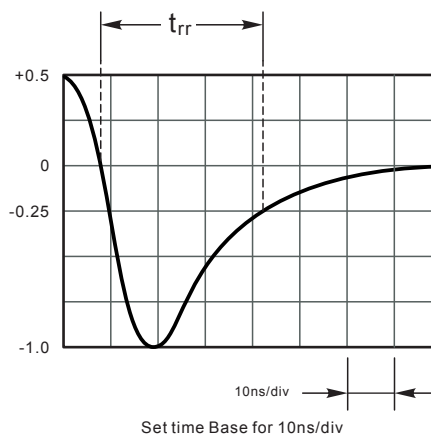


Fig.2 Maximum Average Forward Current Rating

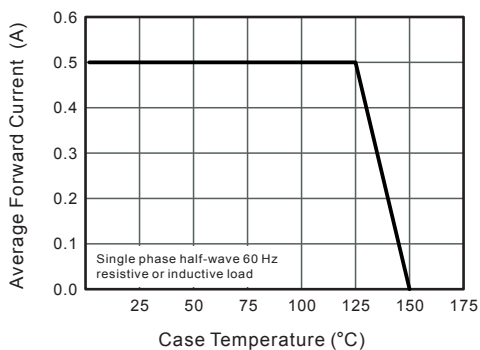


Fig.3 Typical Reverse Characteristics

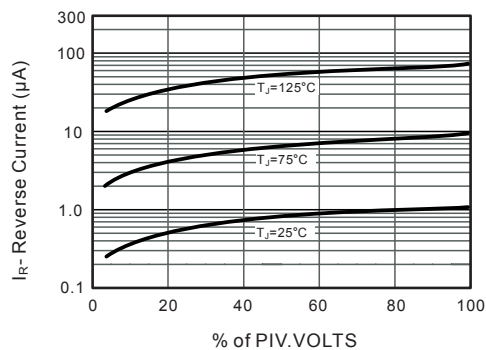


Fig.4 Typical Forward Characteristics

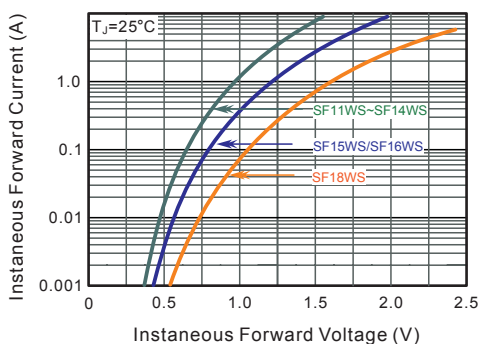


Fig.5 Typical Junction Capacitance

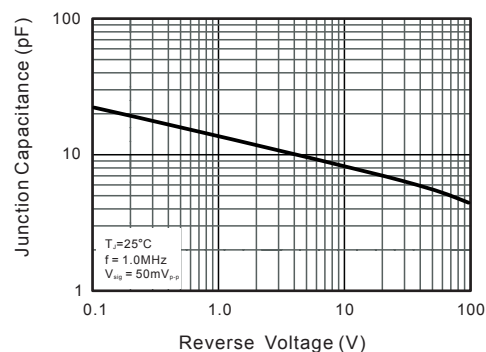
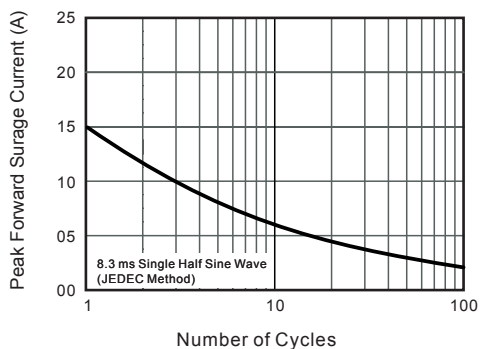
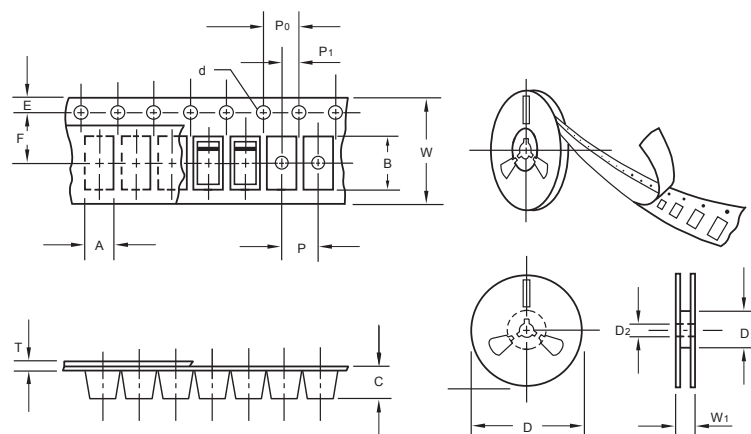


Fig.6 Maximum Non-Repetitive Peak Forward Surge Current



The curve above is for reference only.

Packing information



unit:mm

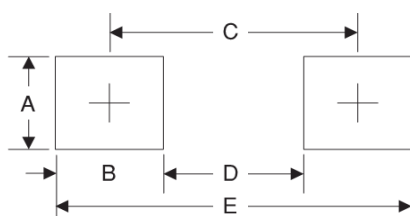
Item	Symbol	Tolerance	SOD-323
Carrier width	A	0.1	1.46
Carrier length	B	0.1	2.90
Carrier depth	C	0.1	1.25
Sprocket hole	d	0.05	1.50
13" Reel outside diameter	D	2.0	330.00
13" Reel inner diameter	D ₁	min	50.00
7" Reel outside diameter	D	2.0	178.00
7" Reel inner diameter	D ₁	min	54.40
Feed hole diameter	D ₂	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	3.50
Punch hole pitch	P	0.1	4.00
Sprocket hole pitch	P ₀	0.1	4.00
Embossment center	P ₁	0.1	2.00
Overall tape thickness	T	0.1	0.06
Tape width	W	0.3	8.00
Reel width	W ₁	1.0	12.30

Note: Devices are packed in accordance with EIA standard RS-481-A and specifications listed above.

Reel packing

PACKAGE	REEL SIZE	REEL (pcs)	COMPONENT SPACING (m/m)	BOX (pcs)	INNER BOX (m/m)	REEL DIA. (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
SOD-323	7"	3,000	4.0	45,000	210*208*203	178	430*430*235	180,000	9.0

Suggested Pad Layout



Symbol	Unit (mm)	Unit (inch)
A	1.2	0.047
B	1.2	0.047
C	2.6	0.141
D	1.4	0.055
E	3.8	0.149